

/ Descriptions

SOT-89 PNP Silicon PNP transistor in a SOT-89 Plastic Package.

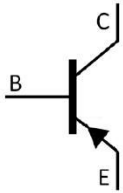
/ Features

Complements the 2SC4672
Low saturation voltage, excellent DC current gain characteristics, complements the 2SC4672.

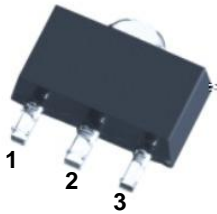
/ Applications

Power amplifier.

/ Equivalent Circuit



/ Pinning



PIN1 Base PIN 2 Collector PIN 3 Emitter

/ Marking

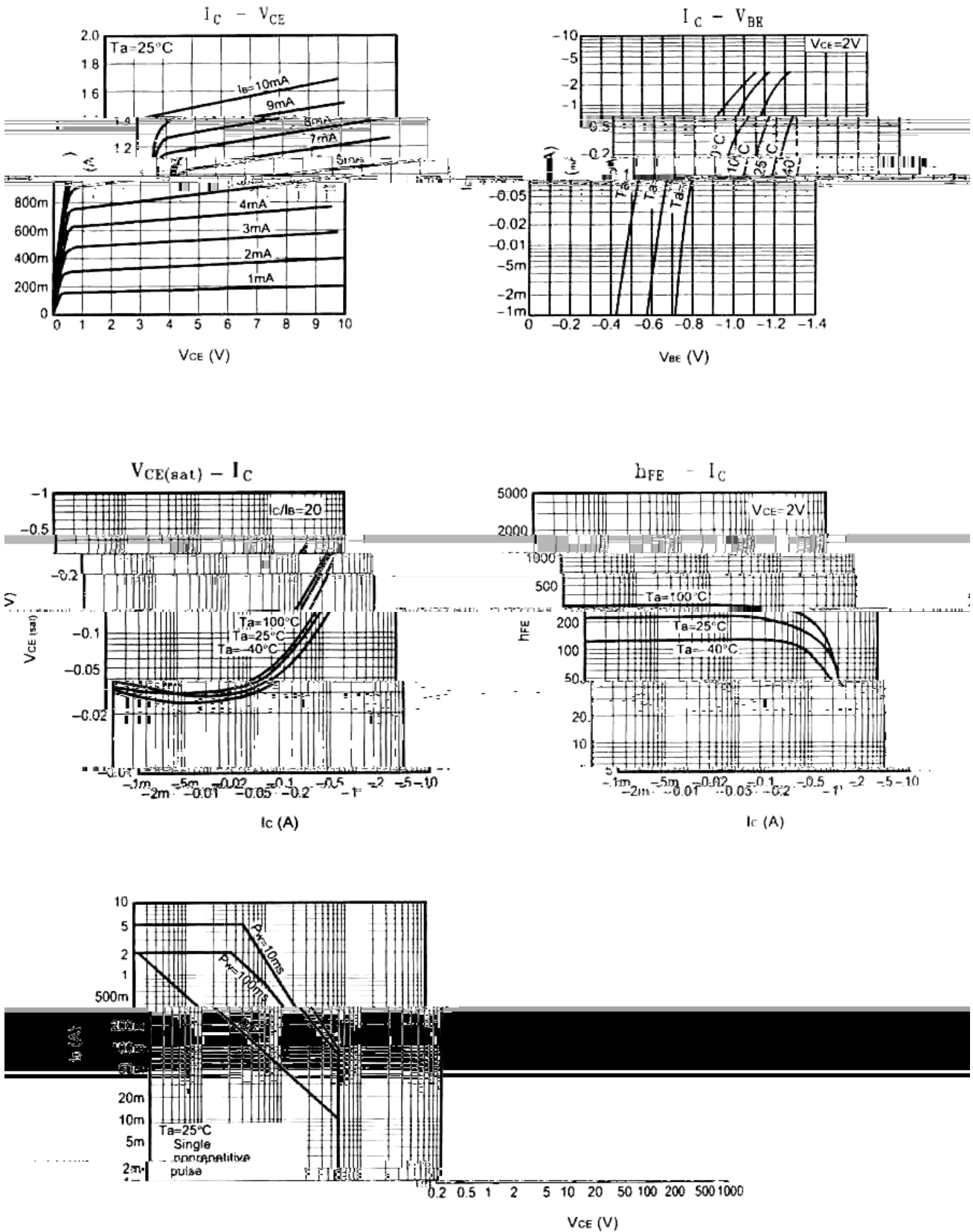
h_{FE} Classifications Symbol	P	Q
h_{FE} Range	82 180	120 270
Marking	HAGP [※]	HAGQ [※]

Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	-50	V
Collector to Emitter Voltage	V_{CEO}	-50	V
Emitter to Base Voltage	V_{EBO}	-6.0	V
Collector Current-Continuous	I_C	-3.0	A
Collector Current -Continuous(Pulse)	I_{CP}	-6.0	A
Collector Power Dissipation	P_C	0.5	W
Collector Power Dissipation*	* P_C	2.0	W
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

*When mounted on a 40x40x0.7mm ceramic board.

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector to Base Breakdown Voltage	V_{CBO}	$I_C=-50$ A	-50			V
Collector to Emitter Breakdown Voltage	V_{CEO}	$I_C=-1.0$ mA	-50			V
Emitter to Base Breakdown Voltage	V_{EBO}	$I_E=-50$ A	-6.0			V
Collector Cut-Off Current	I_{CBO}	$V_{CB}=-50$ V			-0.1	A
Emitter Base Cut-Off Current	I_{EBO}	$V_{EB}=-5.0$ V			-0.1	A
DC Current Gain	h_{FE}	$V_{CE}=-2.0$ V $I_C=-500$ mA				
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=-1.0$ A $I_B=-50$ mA		-0.15	-0.35	V

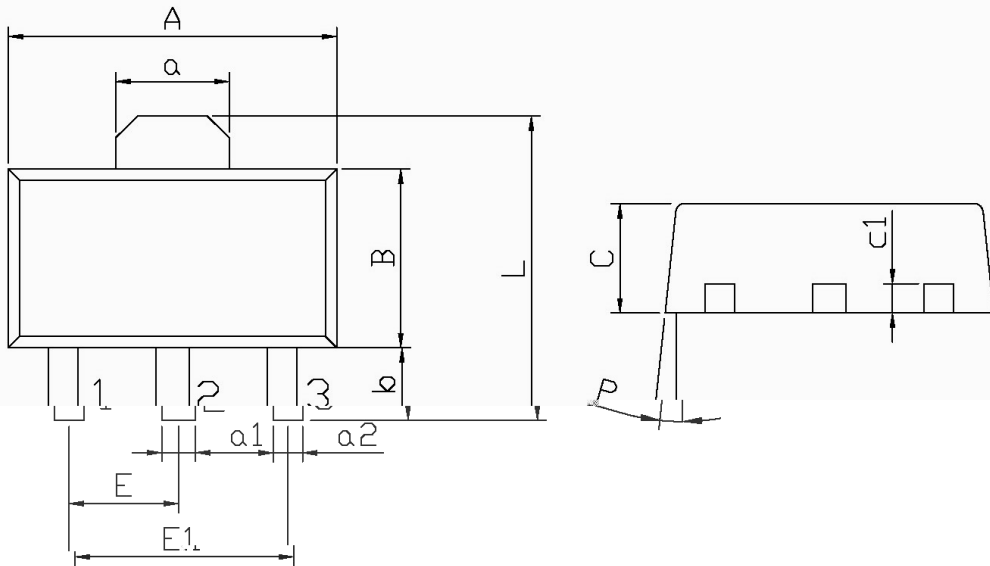
/ Electrical Characteristic Curve



/ Package Dimensions

SOT-89

单位: mm



Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
A	4.4	4.7	a1	0.36	0.56
B	2.35	2.65	a2	0.30	0.50
L	3.878	4.478	C	1.40	1.70
a	1.45	1.65	c1	0.35	0.50
E	1.40	1.60	P	6°	
E1	2.80	3.20			
b	0.80	1.20			

/ Marking Instructions



H

AG

P: h_{FE}

**

Note:

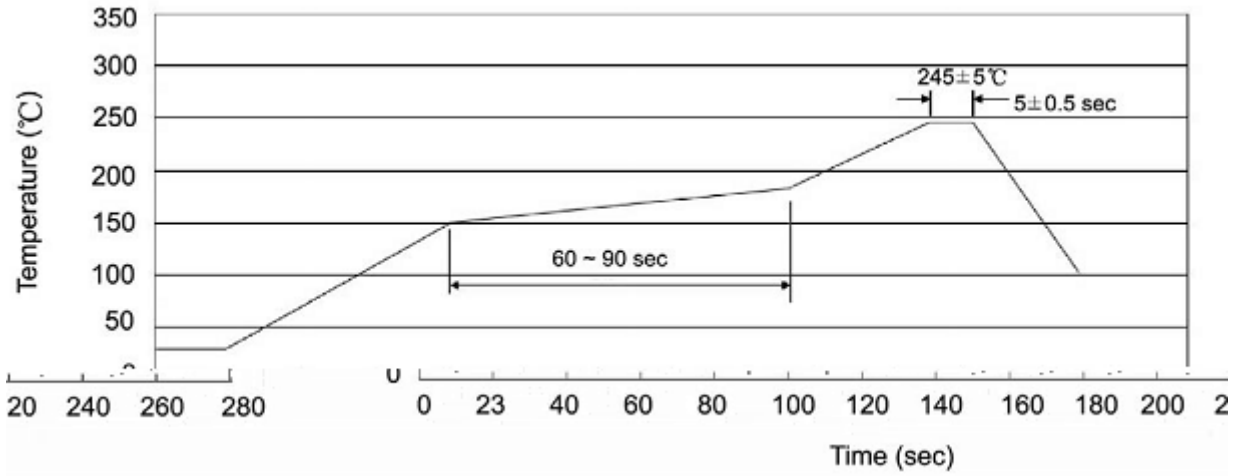
H: Company Code.

AG: Product Type.

P: h_{FE} Classifications Symbol

** : Lot No. Code, code change with Lot No.

() / K\d g\iXk i\`Gif]`d`]fi`@`l`]\]fn`Jfd` \i`e`^ZGY\$=i\`z



Note:

- | | | | | | |
|---|-------|-----|-------|----------|---|
| 1 | 25 | 150 | 60 | 90sec; | 1.Preheating:25~150 , Time:60~90sec. |
| 2 | 245±5 | | 5±0.5 | sec; | 2.Peak Temp.:245±5 , Duration:5±0.5sec. |
| 3 | | | 2 | 10 /sec. | 3. Cooling Speed: 2~10 /sec. |

/ Resistance to Soldering Heat Test Conditions

260±5 10±1 sec. Temp.:260±5 Time:10±1 sec

/ Packaging SPEC.

/ REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	只卷盘	卷盘盒	只盒	盒箱	只箱	盒	箱	

/ Notices